(TUE) 9. 23' 63 12:54/ST. 12:54/NO. 4860347792 P

TREXLER, BUSHNELL, GIANGIORGI, BLACKSTONE & MARR LTD.

COUNSELORS AT LAW

THE CLARK ADAMS BUILDING 105 WEST ADAMS STREET, STITE 3600 CHICAGO, ILLINOIS 60603-6299

(312) 704-1890

FOUNDED THE FICIAL

PATENT, TRADÉMARK, COPYRIGHT AND RELATED MATTERS; ALL PHASES INCLUDING LICENSING AND LITIGATION

> PAX: (312) 704-9033 www.trexlaw.RECEIVED CENTRAL FAX CENTER

> > SEP 2 5 2003

RICHARD R. TREXLER (1906-1995)
RICHARD A. GIANGIORGI
RAIHORD A. BLACKSTONE, JR.
DAVID J. MARR
LINDA L. PALOMAR
JAMES R. FOLEY
JAMES A. O'MALJEY
TIMOTHY M. McCARTHY
PAIGE A. KITZINGER

OF COUNSEL.
RICHARD BUSHNELL

TOTAL PAGES (Including Cover Page) 7	DATE: September 23, 2003				
TOTAL PAGES (melading cover rage)					
Assistant Commissioner for Patents TO: Attn.: Examiner Paresh H. Patel	FROM: Mr. James R. Foley, Reg. No. 39,979				
FAX NO: (703) 872-9319	FAX NO: (312) 704-8023				
If you experience any difficulty with this transmission, please call (312) 704-1890 for assistance.					
ORIGINAL COPY AND ENCLOSURES WILL BE SENT BY MAIL COURIER X WILL NOT BE SENT					

NOTES:

Applicant: Daniel B. D'Souza

For: WAFER LEVEL DYNAMIC

BURN IN

Serial No. 09/918,183

Senai No. 09/916,10

Filed: July 30, 2001

Art Unit: 2829

Examiner: Paresh H. Patel

Ref.: 00-464

CERTIFICATION OF FACSIMILE TRANSMISSION

t hereby certify that this paper is being facsimile transmitted to the Patent

and Trademark Office on September 23, 2003.

James R. Foley, Reg. No. 39,97

IMPORTANT NOTICE

This transmission (including all attached pages) is intended only for the use of the named addressee(s), and may contain information that is privileged or exempt from disclosure under applicable law. IF YOU ARE NOT A NAMED ADDRESSEE, YOU ARE HEREBY NOTIFIED THAT ANY USE, DISSEMINATION, DISTRIBUTION OR COPYING OF THIS TRANSMISSION IS STRICTLY PROHIBITED. If you have received this transmission in error, please destroy all copies and notify us immediately at this telephone number: (312) 704-1890.

FROM TREXLER ETAL.

(TUE) 9. 23' 03 12:55/ST. 12:54/NO. 4860347792 P 2 Case Docket No. 00-464

> CERTIFICATION OF FACSIMILE TRANSMISSION i horeby certify that this paper is being facsimile transmitted to the United Stales Patent and Trodemark Office on September 23, 2003

FORM PTO-1083

In re application of:

Daniel B. D'Souza

Serial No.:

09/918,183

Filed:

July 30, 2001

For

WAFER LEVEL DYNAMIC BURN IN

COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, VA 22313-1450

Transmitted herewith is a Response to the Office Action Mailed July 30, 2003 for the above-identified application.

The filing fee has been calculated as shown below:

	(Col. 1)		(Col. 2)	(Col. 3)	
	Claims Romaining After Amendment		Highest No Previously Paid for	Present Tixtra	
TOTAL	* 5	MINUS	** 20	0	
INDEP.	* }	MINUS	** 3	0	
☐ FIRST PRESENTATION OF MULTIPLE DEP. CLAIM					

x 42 🖚 \$.00 \$.00 + 130 =

TOTAL

ADDIT. FEE

x 9 =

SMALL ENTITY

Addit

\$ 00

\$.00

<u>OX</u>

SMALL ENTITY Addit. QR. Rate x 18 = \$.00 x 84 =\$.00 +260 =\$.00 TOTAL \$.00

OTHER TIIAN A

If the entry in Col. 1 is less than the entry in Col. 2, write " θ " in Col. 3.

If the "Highest Number Previously Paid For" IN THIS SPACE is less than 20, write "20" in this space. If the "Highest Number Previously Paid For" IN THIS SPACE is less than 3, write "3" in this space.

The "Highest Number Previously Paid For" (Total or independent) is the highest number found from the equivalent box in Col. l of a prior amendment or the number of claims originally filed.

Please charge my Deposit Account No. 12-2252 in the amount of \$	A duplicate copy of this sheet is
enclosed.	

The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 12-2252.

Any filing fees required under 37 CFR 1.16 for the presentation of extra claims. \boxtimes

 \boxtimes Any patent application processing fees under 37 CFR 1.17

Dated: September 23, 2003

R. Foley, Reg. No. 39,9

Attorney of Record

PATENT

			CENTRAL FAX CENTER
Serial No.:	09/918,183)	SEP 2 5 2003
Filed:	July 30, 2001)	OFFICIA
Art Unit:	2829))	CERTIFICATION OF FACSIMILE TRANSMISSION
Examiner:	Peresh Patel)	I hereby certify that this paper is being facsimile transmitted to the Fatent and Trademark Office on September 23, 2003.
For: WAFE BURN	R LEVEL DYNAMIC IN)	James R Foley, Reg No. 39,979
Applicant: I	D'Souza)	

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

RESPONSE TO OFFICE ACTION MAILED JULY 30, 2003

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 Mail Stop Non-Fee Amendment

00-464

Sir:

Attorney Ref:

In the matter of the above-identified application and in response to the Office Action mailed July 30, 2003, kindly consider the following amendment and remarks toward reconsideration of the present application. The Office Action was indicated as being final, and the present Response is being filed within two months of the mailing date of the Office Action.

(TUE) 9. 23' 03 12:55/ST. 12:54/NO. 4860347792 P 4

AMENDMENTS

Please amend the claims as follows:

(Currently amended) A wafer comprising:

a plurality of DRAM dies on the wafer, wherein each DRAM die has a test data in

pad and a test data out pad; and

conductive connections interconnecting the test data out and test data in pads of

the DRAM dies, said conductive connection providing that said DRAM's can be burned-

in on the wafer, wherein the DRAM dies on the wafer are arranged in rows, wherein each

row comprises a plurality of DRAM dies and each DRAM die in a given row is daisy

chained to the next DRAM die in the row, wherein the last DRAM die in a row is daisy

chained to the first DRAM die in the next row via a metal line on a scribe area of the

wafer, wherein the DRAM dies on the wafer are connected to power busses along a scribe

area so that the dies can be powered.

2. (Original) The wafer as recited in claim 1, wherein the DRAM dies are

IEE1149.1 (JTAG) compliant, and include the following pads: TDI (Test Data In), TDO

(Test Data Out). TCK (Test Clock) and TMS (Test Mode Set).

Serial No.: 09/918,183

Art Unit: 2829

Page 2

- 3. (Original) The wafer as recited in claim 2, wherein the TDO pad of each DRAM die is connected to the TDI pad of the next DRAM die on the wafer.
- 4. (Original) The wafer as recited in claim 2, wherein the TMS and TCK pads of the DRAM dies are connected in parallel.
- 5. (Original) The wafer as recited in claim 4, wherein the TMS and TCK pads of the DRAM dies are connected via metal lines running along a scribe area of the wafer.
 - 6. (Canceled)
 - 7. (Canceled)
 - 8. (Canceled)
 - 9. (Canceled)
 - 10-20. (Withdrawn)

Serial No.: 09/918,183

Art Unit: 2829

Page 3